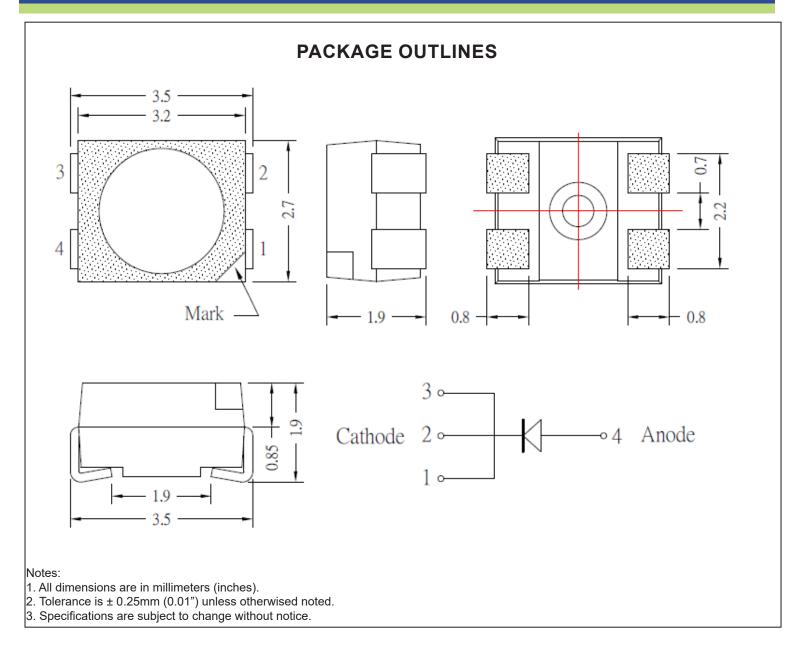


#### SPECIFICATION

# CSP1311R3CB-4



Part Number	Chip Material	Color of Emission	Lens Type/Face	Viewing Angle	
CSP1311R3CB-4	InGaAlP	Red	Water Clear/Black	120°	





## **ABSOLUTE MAXIMUM RATINGS**

#### (TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	70	mA	
Reverse Current @ 5V	lR	10	μA	
Power Dissipation	Pd	130	mW	
Operating Temperature Range	Тор	-40~+100	°C	
Storage Temperature Range	Tstg	-40~+100	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	100	mA	
Soldering Temperature	Tsol	Max 265°C for 10 sec Max		

## OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

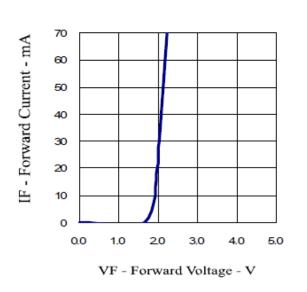
Deremeter	Symbol	Test Condition	Value			Lipit
Parameter		Test Condition	Min	Тур	Max	Unit
Luminous Intensity	١v	IF = 50mA	1500	2200	-	mcd
Forward Voltage	Vf	IF = 50mA	-	2.2	2.6	V
Reverse Leakage Current	lr	VR = 5V	-	-	10	μA
Viewing Angle at 50% Iv	201/2	IF = 50mA	-	120	-	Deg
Peak Wavelength	λp	IF = 50mA	-	635	-	nm
Dominant Wavelength	λD	IF = 50mA	615	625	635	nm

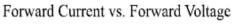
\*Tolerance of viewing angle: -10 / +5 deg.

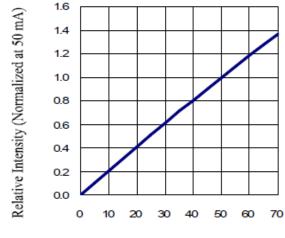




#### **OPTICAL CHARACTERISTIC CURVES**



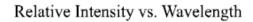


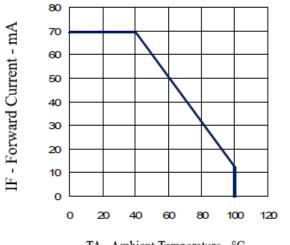


Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature





TA - Ambient Temperature - °C

1.2 TA=25°C IF=20mA 1.0 0.8 0.6 0.4 0.2 0.0 500 550 600 650 700 Wavelenth - nm

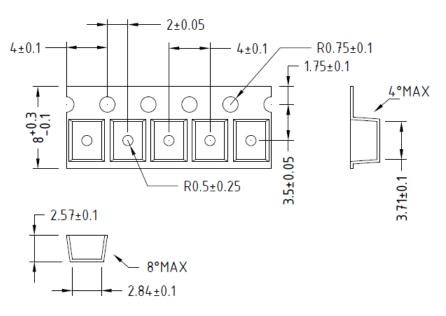


Relative Intensity (Normalized at 50 mA)

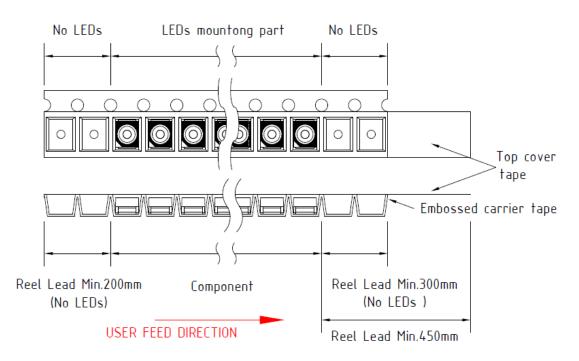


### PACKAGING SPECIFICATION

#### **TAPE DIMENSION**



#### TAPE LEADER AND TRAILER DIMENSION



#### Notes:

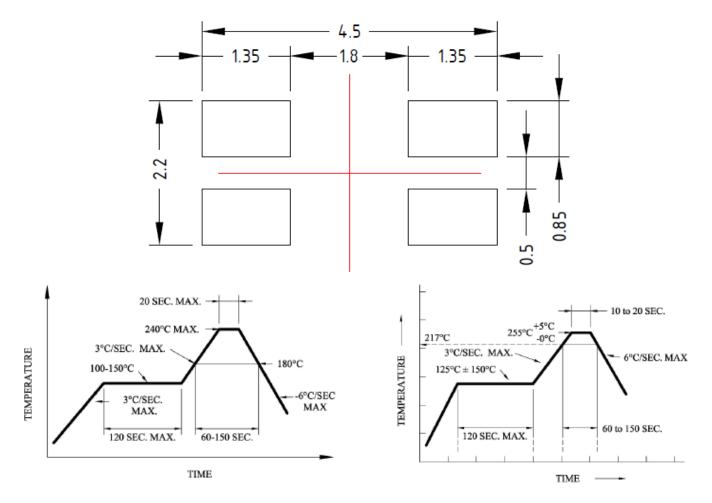
- 1. Empty component pockets are sealed with top cover tape
- 2. The maximum number of missing lamps is two.
- 3. 2000 pcs/reel



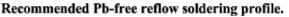


## SOLDERING CONDITIONS

#### **RECOMMENDED SOLDERING PAD PATTERN**







- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board

